

**ABSTRACT OF THE DISCLOSURE**

5 A wafer-shipping device and a wafer storage method for protecting  
bonding pads from fluoridation. First, at least one through hole is  
drilled in the shipping box . The wafer is then placed in the shipping  
box. A packaging bag containing the shipping box is put into a vacuum  
packaging machine to remove air from the packaging bag and the shipping  
box. A dry inert gas is then introduced into the packaging bag and  
the shipping box until approaching atmospheric pressure as so to  
10 prevent the shipping box from collapse. The packaging bag is then  
sealed.